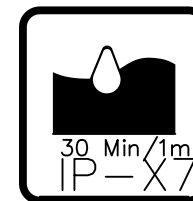


REV.	ECN NO	CONTENT	DATE	ENGINEER
A0		Initial release	/	TSP

NOTES:

1. MATERIAL: SEE "TABLE 1";
2. FINISH: SEE "TABLE 1";
3. ELECTRICAL :
 - 3-1.CONTACT CURRENT RATING :
5A(VBUS PIN 1.5A/PIN),
5A(GND PIN 1.25A/PIN MAX),0.25A/PIN(OTHER PIN).
 - 3-2.INSULATION RESISTANCE :
100 MEGAOHMS MIN. AT 250VDC.
 - 3-3.DIELECTRIC WITHSTANDING VOLTAGE :
100VAC MIN.
 - 3-4.LOW LEVEL CONTACT RESISTANCE :
INITIAL 40mΩ MAX.
AFTER 50mΩ MAX.
- 4.MECHANICAL CHARACTERISTICS :
 - 4-1. MATING FORCE: 5~20N.
 - 4-2. UNMATING FORCE: 8~20N(INITIAL),6~20N(AFTER 10000 CYCLES);
 - 4-3.DURABILITY : 10,000 MATING CYCLES.
 - 4-4.OPERATING TEMPERATURE : -40°C TO +80°C



SECTION A-A

WELDING POINT

RECOMMENDED P.C.B LAYOUT(Both sides are sample)
Tolerance:±0.05,Thickness=0.60mm

TABLE 1:

NO.	PART NAME	QTY	MATERIAL	DESCRIPTION	REMARK
⑧	GLUE WATER	1	Epoxy	BLACK;	
⑦	Shell-2	1	Stainless steel	PEARL NI PLATING;	T=0.20mm
⑥	Shell-1	1	Stainless steel	PEARL NI PLATING;	T=0.20mm
⑤	GND PLATE	1	Stainless steel	NI PLATING;	T=0.10mm
④	MID PLATE	1	Stainless steel		T=0.15mm
③	Terminal-B	12		CONTACT AREA:AU15u"	T=0.12mm
②	Terminal-A	12	C7025	CONTACT AREA:AU15u"	T=0.12mm
①	Housing	1	HIGH TEMP NYLON	Black	



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PDWG,NO: 0842-1

深圳市步步精科技有限公司	
.X: ±0.38 .XX: ±0.25 .XXX: ±0.13	X': ±3" .X': ±2" .XX': ±1"
NAME:TYPE-C 24P 防水母座 四脚插 端子SMT+DIP 镀金15U 沉板1.40 L=9.65 CH=0.30 IPX7 编带	
APPD. JM_Zheng	PJ. NO.:126-273-240001-W2G SIZE: A4 DRW NO.:
CHKD. LYX	FINISH: SEE NOTES MAT'L.: SEE NOTES
DR. TSP	SCALE: N/A REV.: A0 UNIT: mm PAGE: 1/3

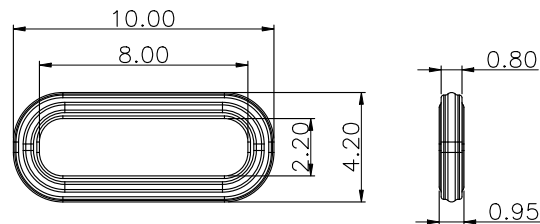
密封方式

机壳面板

SEAL RUBBER

PCB

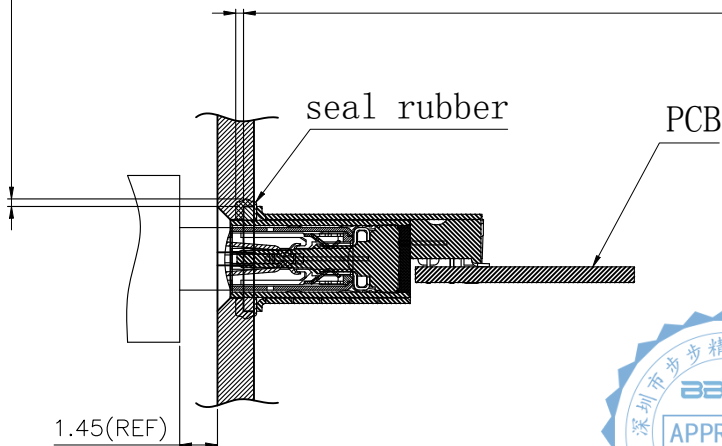
前后组装方式



Seal Rubber For Reference

Space(Panel with Seal Rubber)0.30Min
(The amount of compression is recommended as 40%~50% of seal rubber O.D.)

Space(Panel with Seal Rubber)0.30Min
(The amount of compression is recommended as 40%~50% of seal rubber O.D.)



Recommended Assembly



REV.	ECN NO	CONTENT	DATE	ENGINEER
A0		Initial release	/	TSP

Pin	Signal Name	Mating Sequence	Pin	Signal Name	Mating Sequence
A1	GND	First	B12	GND	First
A2	SSTXp1	Second	B11	SSRXp1	Second
A3	SSTXn1	Second	B10	SSRXn1	Second
A4	V _{BUS}	First	B9	V _{BUS}	First
A5	CC1	Second	B8	SBU2	Second
A6	Dp1	Second	B7	Dn2	Second
A7	Dn1	Second	B6	Dp2	Second
A8	SBU1	Second	B5	CC2	Second
A9	V _{BUS}	First	B4	V _{BUS}	First
A10	SSRXn2	Second	B3	SSTXn2	Second
A11	SSRXp2	Second	B2	SSTXp2	Second
A12	GND	First	B1	GND	First
SHELL		GND	SHELL		GND

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.X: ±0.38 .X': ±3"
.XX: ±0.25 .X": ±2"
.XXX: ±0.13 .XX': ±1"

NAME:TYPE-C 24P 防水母座 四脚插 端子SMT+DIP
镀金15U 沉板1.40 L=9.65 CH=0.30 IPX7 编带

APPD. JM_Zheng

PJ. NO.:126-273-240001-W2G

CHKD. LYX

SIZE: A4 DRW NO.:

DR. TSP

FINISH: SEE NOTES MAT'L.: SEE NOTES

SCALE: N/A REV.: A0 UNIT: mm PAGE: 2/3

REV.	ECN NO	CONTENT	DATE	ENGINEER
A0		Initial release	/	TSP

包装方式:

第一步: 产品使用包装机入包装盘

- (1) 首先将包装盘贴上标签
- (2) 再将成品按照规定的所示方向摆放于料带中进行包装
- (3) 每盘包装数量700PCS成品

第二步: 包装盘入外箱

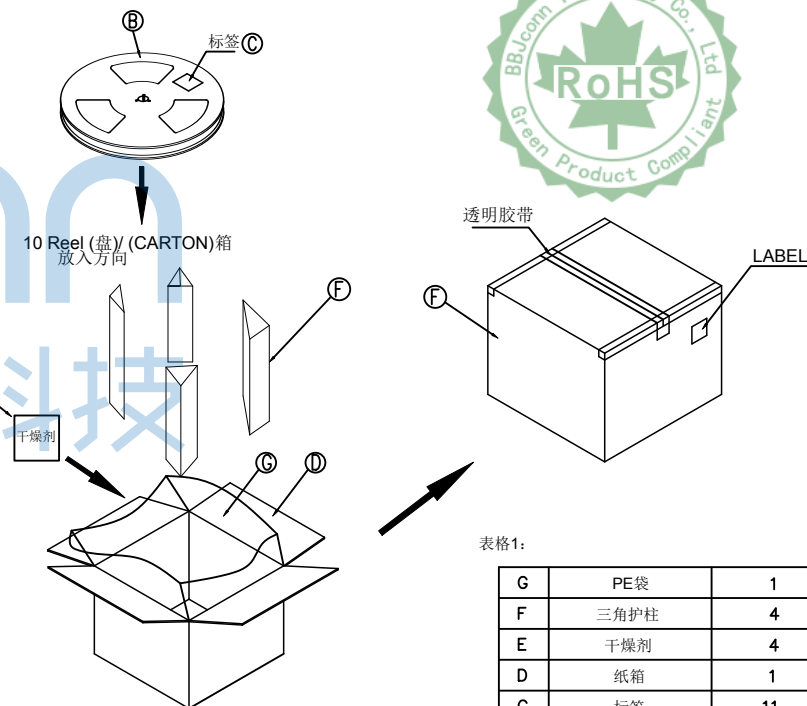
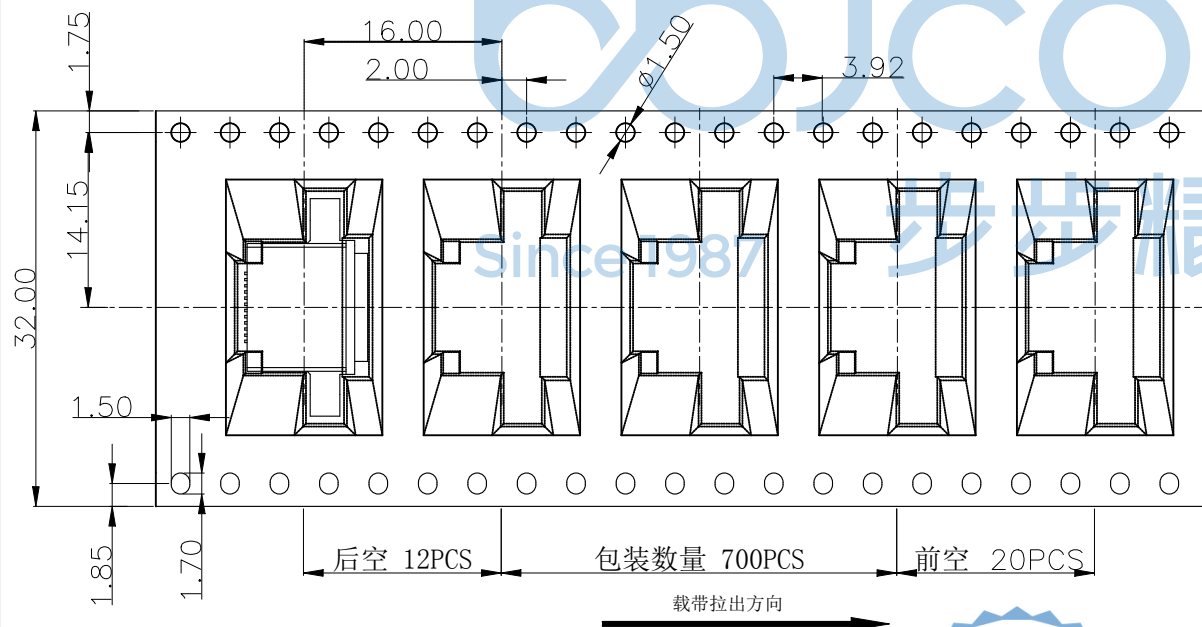
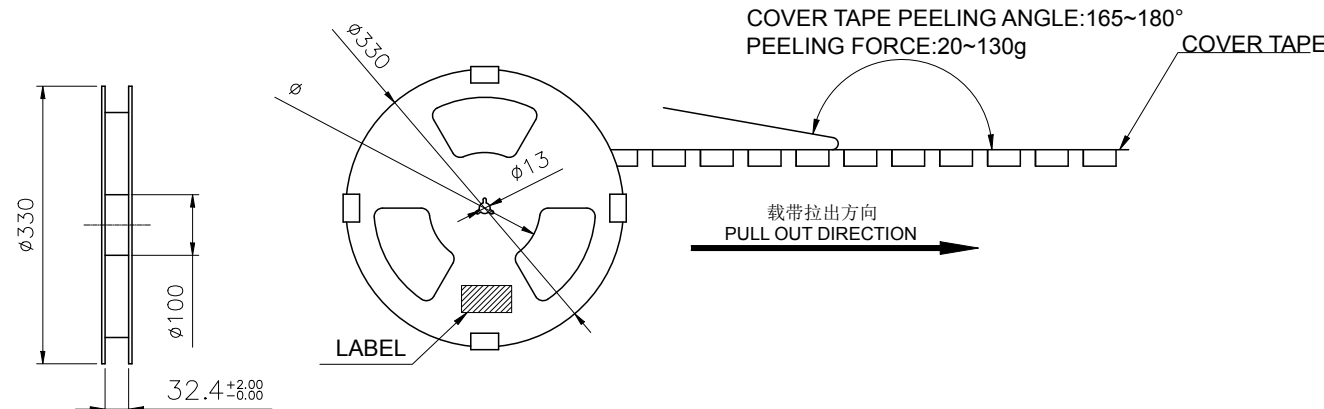
- (1) 每个PE袋中放入四包干燥剂,
- (2) 共10盘/7000PCS放入置入外箱的PE袋中

第三步: 外箱封口&贴标签

- (1) 先确认外箱里是否有10盘产品
- (2) 包装完成后使用透明胶带封口, 贴LABEL于规定的位置

第四步: 储存&运输

- (1) 储存在通风, 干燥环境; 搬运时轻拿轻放



表格1:

NO	DESCRIPTION	Q'TA(PCS)
G	PE袋	1
F	三角护柱	4
E	干燥剂	4
D	纸箱	1
C	标签	11
B	REEL	10
A	TYPE C	7000

防水胶圈包装 (两者独立包装)

700	10	7000
PCS/	REEL/	PCS/
REEL	CARTON	CARTON



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		SCALE: N/A	REV.: A0 UNIT: mm PAGE: 3/3